

PRODUCT RELIABILITY REPORT FOR

DS1921, Rev C1

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

DS1921, Rev C1

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

 $AfT = \exp((Ea/k)^*(1/Tu - 1/Ts)) = tu/ts$

AfT = Acceleration factor due to Temperature

tu = Time at use temperature (e.g. 55°C)

ts = Time at stress temperature (e.g. 125°C)

k = Boltzmann's Constant (8.617 x 10-5 eV/°K)

Tu = Temperature at Use (°K)

Ts = Temperature at Stress (°K)

Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

 $AfV = exp(B^*(Vs - Vu))$

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)

X = Chi-Sq statistical upper limit

N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 18096 FITS: 6.3

DEVICE HOURS: 154000 FAILS: 0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.25 Volts

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "*" after DATE CODE denotes specific product data.

Device Information:

Process: E6LA-2P2M,LLVt,PF,TCN1 ALOCOS:GOI Passivation: NRL Laser w/Nov TEOS Oxide-Nitride

Die Size: 138 x 172 Number of Transistors: 187762

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 150 Å

ELECTRICAL	. CHARA	CTERIZATION
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DESCRIPTION	DATE CODI	E CONDITION	REA	DPOINT	QTY	FAILS	FA#
ESD SENSITIVITY	0619 *	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0619 *	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0619 *	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0619 *	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	0619 *	IEC 61000-4-2 CONTACT 2000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0619 *	IEC 61000-4-2 CONTACT 4000 VOLTS	10	PUL'S	3	0	
ESD SENSITIVITY	0619 *	IEC 61000-4-2 CONTACT 8000 VOLTS	10	PUL'S	3	3	No FA
LATCH-UP	0619 *	JESD78, V-SUPPLY TEST 125C			3	0	
				Total:		3	

OPERATING LIFE								
DESCRIPTION	DATE COD	E CONDITION			READPOINT	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0549	125C, 5.5V (PS	A) & 3.0V (PSB)		1000 HRS	77	0	
HIGH TEMP OP LIFE	0619 *	125C, 5.25 VO	LTS		1000 HRS	77	0	
FAILURE RATE:	МТ	TF (YRS):	18096	FITS:	Total: 6.3		0	

FAILURE RATE: MTTF (YRS): 18096 FITS: 6.3

DEVICE HOURS: 154000 FAILS: 0